

# **Product Compliance Declaration**

Please see <u>www.molex.com</u> for the most up-to-date information.

**Contact Information** 

Name Molex Product Compliance E-Mail Product.Compliance@molex.com

**Part Information** 

Part Number 0901200122 Part Weight 0.12225G

Part Name C-Grid SR Vt Pn 6.75/2.90mm Tn-A 2Ckt

## **Product Composition**

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
C-Grid SR Vt Pn 6.75/2.90mm Tn-A 2Ckt	Assembly		100	0.12225
S-ROW C-GRID WAFER 901200040	Component		26.544	0.03245
PBT GF BLACK	Material		26.544	0.03245
PBT	Substance		18.128	0.022161
Flame Retardant, ISO 1043-4 FR(17)	Substance		3.0604	0.003741
Antimonytrioxide	Substance	1309-64-4	1.2647	0.001546
Further Additives	Substance	system	0.2342	0.000286
GF-Fiber	Substance		3.8567	0.004715
C-GRID PIN - TIN PLATED 901292003	Assembly		73.456	0.0898
BANDOLIER PIN U/P 903182003	Component		68.5481	0.0838
Cartridge Brass 70% Unplated	Material		68.5481	0.0838
Copper	Substance	7440-50-8	47.9836	0.05866
Zinc (metal)	Substance	7440-66-6	20.5644	0.02514

#### Form Rev - F

Limitation of this Product Compliance Declaration: This declaration is based on the state of knowledge and belief of Molex as of the date that it is provided. Molex bases its knowledge and belief on information provided by numerous sources, including third parties, and in certain circumstances laboratory test results. Molex has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and substances. Molex represents that to the best of its knowledge that the information provided in this declaration is accurate. Molex's sole liability shall be to either replace the product or refund the purchase price of the product if it does not meet the requirement of this declaration.

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
Nickel Plating	Material		1.636	0.002
Nickel	Substance	7440-02-0	1.6358	0.002
Further Additives	Substance	system	0.0002	2E-7
Tin Plating	Material		3.272	0.004
Tin	Substance	7440-31-5	3.272	0.004

## **ROHS Declaration Information**

Regulatory Revision 2011/65/EU

Compliance Status Compliant

**Contained Substances Exceeding Threshold** 

None

**Exemptions** 

None

# **REACH-SVHC Declaration Information**

Regulatory Revision ED/30/2017 (7 July 2017)

**Contained Substances Exceeding Threshold** 

None

### **GADSL Declaration Information**

Regulatory Revision GADSL imported from IMDS

## **Contained Substances Exceeding Threshold**

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
Lead	Cartridge Brass 70% (CA260)	*Note	350	Yes
Lead	e-plate Sn (electrodeposited Tin	*Note	150	Yes

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Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
Antimonytrioxide	PBT GF BLACK	*Note	60,000	Yes
Nickel	Ep-Ni	*Note	997,500	Yes
Copper	Cartridge Brass 70% (CA260)	*Note	700,000	Yes
Glass fibres	PBT GF BLACK	*Note	170,000	Yes

<sup>\*</sup>Note: For GADSL substance declarable/prohibited threshold values, please reference http://www.gadsl.org/

# **Exemptions**

Part Name	Exemption
Cartridge Brass 70% (CA260)	44 Concentration within acceptable GADSL limits
e-plate Sn (electrodeposited Tin Coatings, bright and matt)	44 Concentration within acceptable GADSL limits
Ep-Ni	33 Other application (Surface not routinely touched or nickel release rate < 0.5µg/cm2/week)

## **HFLH Declaration Information**

Regulatory Revision IEC 61249-2-21

## **Contained Substances Exceeding Threshold**

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
Bromine and its compounds	PBT GF BLACK	900	140,000	Yes
Bromine and Chlorine combined	PBT GF BLACK	1,500	140,000	Yes

## **China ROHS Declaration Information**

Part Number	0901200122							
Part Name	C-Grid SR Vt Pn 6.75/2.90mm Tn-A 2Ckt	<b>(e)</b>						
Part Information	on			Ha	zardous S	Substance	es	
Components			Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
C-Grid SR Vt	t Pn 6.75/2.90mm Tn-A 2Ckt		0	0	0	0	0	0
S-ROW C-GI	RID WAFER 901200040		0	0	0	0	0	0

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Components	Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
C-GRID PIN - TIN PLATED 901292003	0	0	0	0	0	0
BANDOLIER PIN U/P 903182003	0	0	0	0	0	0

# **Process Information**

Component Plating / Surface Finish	BSn-Ni
Termination Base Alloy	Brass
Solder Alloy	SnAgCu
Process Capability	WAVE
Maximum Exposure Time (seconds)	010
Maximum Process Temperature (C)	230
Maximum Cycles at Reflow Temperature	001
J-STD-020 Moisture Sensitivity Level	1

Aug 2, 2017